

H5N2503P

Silicon N Channel MOS FET
High Speed Power Switching

REJ03G1105-0200

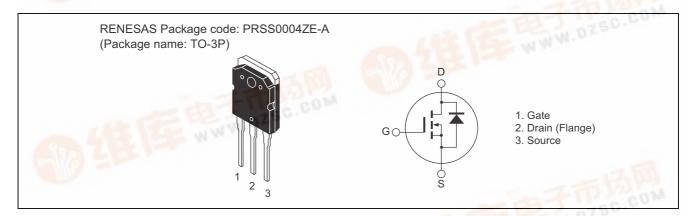
(Previous: ADE-208-1374A) Rev.2.00

Sep 07, 2005

Features

- Low on-resistance: $R_{DS \text{ (on)}} = 0.04 \Omega \text{ typ.}$
- Low leakage current: $I_{DSS} = 1 \mu A \max (at V_{DS} = 250 \text{ V})$
- High speed switching: $t_f = 190$ ns typ (at $V_{GS} = 10$ V, $V_{DD} = 125$ V, $I_D = 25$ A)
- Low gate charge: Qg = 140 nC typ (at $V_{DD} = 200 \text{ V}$, $V_{GS} = 10 \text{ V}$, $I_D = 50 \text{ A}$)
- Avalanche ratings

Outline





Absolute Maximum Ratings

 $(Ta = 25^{\circ}C)$

Item	Symbol	Value	Unit
Drain to source voltage	V _{DSS}	250	V
Gate to source voltage	V _{GSS}	±30	V
Drain current	I _D	50	A
Drain peak current	I _{D (pulse)} Note 1	200	A
Body-drain diode reverse drain current	I _{DR}	50	A
Body-drain diode reverse drain peak current	I _{DR (pulse)} Note 1	200	A
Avalanche current	I _{AP} Note 3	50	A
Channel dissipation	Pch Note 2	150	W
Channel to case thermal Impedance	θ ch-c	0.833	°C/W
Channel temperature	Tch	150	°C
Storage temperature	Tstg	-55 to +150	°C

Notes: 1. PW \leq 10 μ s, duty cycle \leq 1%

2. Value at Tc = 25°C

3. Tch ≤ 150°C

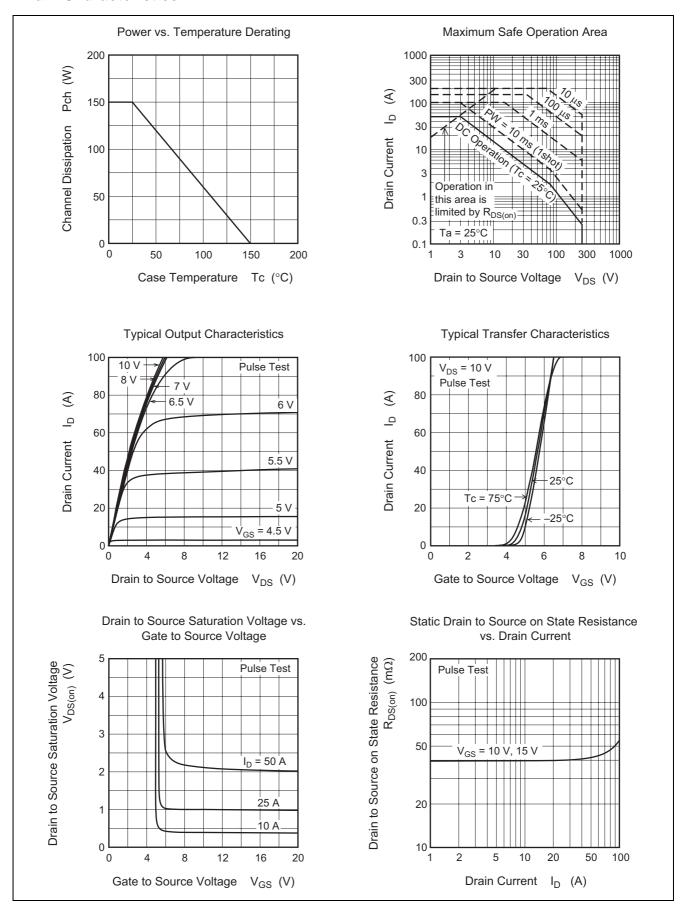
Electrical Characteristics

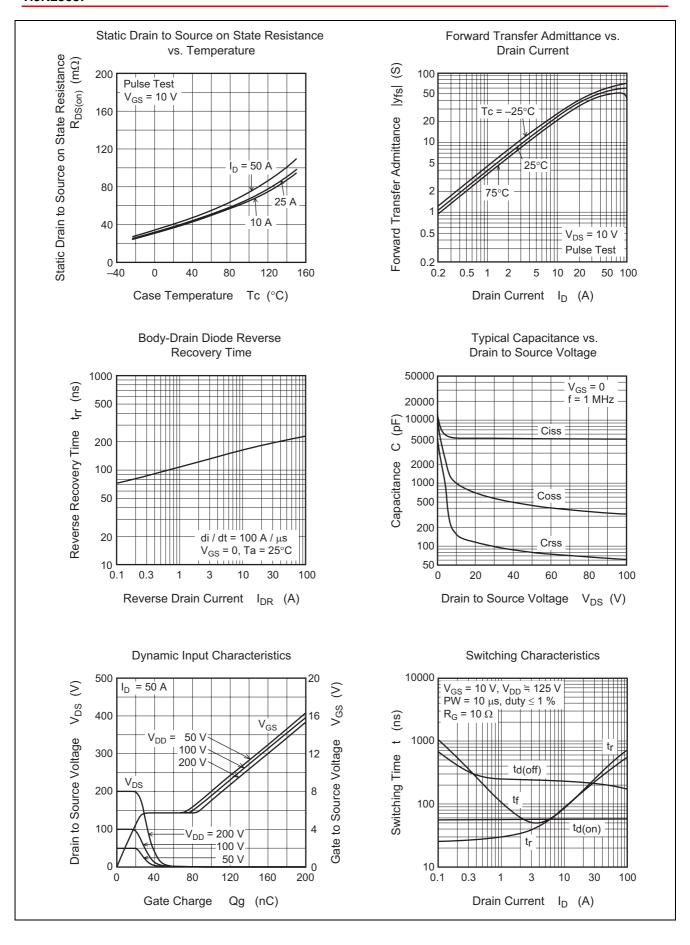
 $(Ta = 25^{\circ}C)$

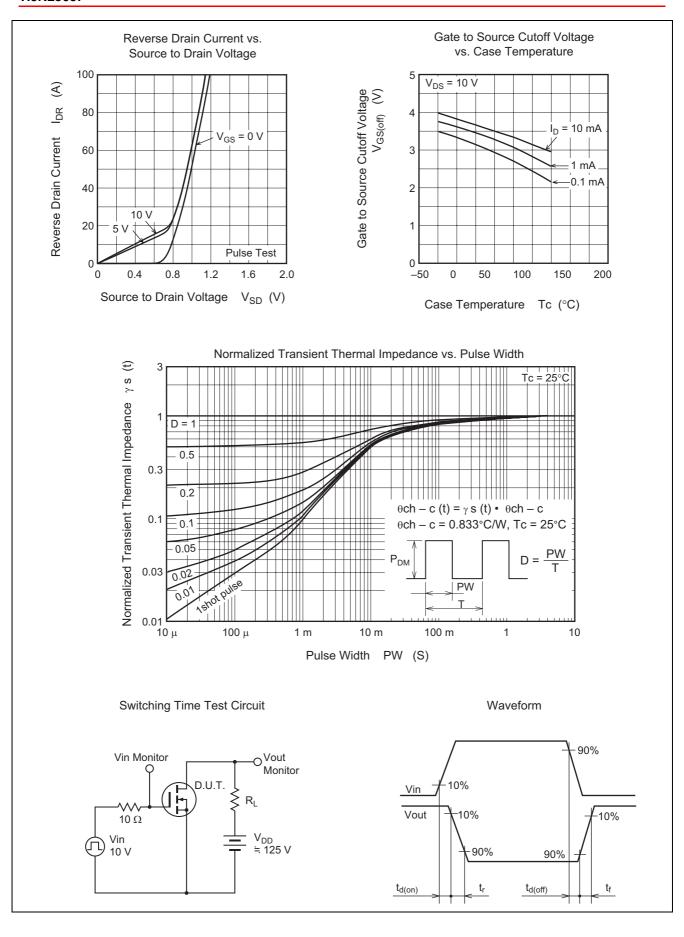
Item	Symbol	Min	Тур	Max	Unit	Test Conditions
Drain to source breakdown voltage	V _{(BR) DSS}	250		_	V	$I_D = 10 \text{ mA}, V_{GS} = 0$
Gate to source leak current	I _{GSS}	_		±0.1	μΑ	$V_{GS} = \pm 30 \text{ V}, V_{DS} = 0$
Zero gate voltage drain current	I _{DSS}			1	μΑ	$V_{DS} = 250 \text{ V}, V_{GS} = 0$
Gate to source cutoff voltage	V _{GS (off)}	3.0		4.0	V	$V_{DS} = 10 \text{ V}, I_{D} = 1 \text{ mA}$
Static drain to source on state resistance	R _{DS (on)}	_	0.040	0.055	Ω	$I_D = 25 \text{ A}, V_{GS} = 10 \text{ V}^{\text{Note 4}}$
Forward transfer admittance	y _{fs}	25	40	_	S	$I_D = 25 \text{ A}, V_{DS} = 10 \text{ V}^{\text{Note 4}}$
Input capacitance	Ciss	_	5150	_	pF	V _{DS} = 25 V
Output capacitance	Coss	_	620	_	pF	$V_{GS} = 0$
Reverse transfer capacitance	Crss	_	105	_	pF	f = 1 MHz
Turn-on delay time	t _{d (on)}	_	58	_	ns	I _D = 25 A
Rise time	t _r	_	210	_	ns	V _{GS} = 10 V
Turn-off delay time	t _{d (off)}	_	220	_	ns	$R_L = 5 \Omega$
Fall time	t _f	_	190	_	ns	$Rg = 10 \Omega$
Total gate charge	Qg	_	140	_	nC	V _{DD} = 200 V
Gate to source charge	Qgs	_	25	_	nC	V _{GS} = 10 V
Gate to drain charge	Qgd	_	60	_	nC	I _D = 50 A
Body-drain diode forward voltage	V_{DF}	_	1.0	1.5	V	I _F = 50 A, V _{GS} = 0
Body-drain diode reverse recovery time	t _{rr}	_	210	_	ns	I _F = 50 A, V _{GS} = 0
Body-drain diode reverse recovery charge	Q _{rr}	_	1.8	_	μС	di _F /dt = 100 A/μs

Note: 4. Pulse test

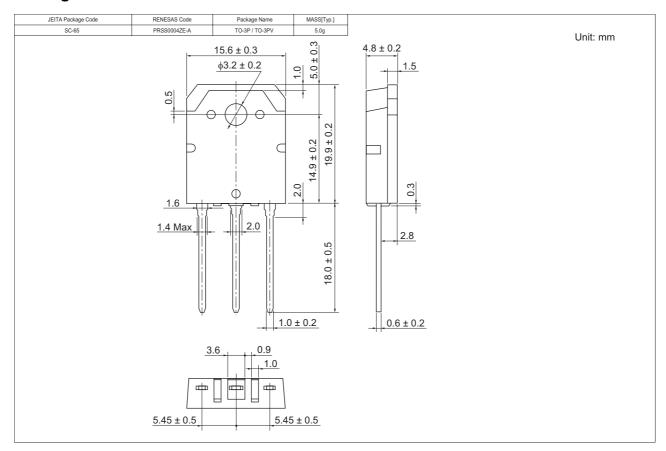
Main Characteristics







Package Dimensions



Ordering Information

Part Name	Quantity	Shipping Container
H5N2503P-E	360 pcs	Box (Tube)

Note: For some grades, production may be terminated. Please contact the Renesas sales office to check the state of production before ordering the product.

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